


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	ADG/20/11988	
1.3 Title of PCN	SPC560Bxx (FB64): Activation of TSMC as Additional Diffusion Plant (Following PCI ADG/19/11411)	
1.4 Product Category	see list	
1.5 Issue date	2020-02-06	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Luca RODESCHINI
2.1.2 Marketing Manager	Selica RUSSI
2.1.3 Quality Manager	Alberto MERVIC

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Wafer fabrication	TSMC Subcontractor recipient (Taiwan)

4. Description of change

	Old	New
4.1 Description	ST Crolles (France) Diffusion plant	ST Crolles (France) Diffusion plant TSMC (Taiwan) Additional Diffusion Plant
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change

5.1 Motivation	Dual sourcing strategy. Following PCI ADG/19/11411 dated March 2019
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	Dedicated Finished Good Codes
------------------------	-------------------------------

7. Timing / schedule

7.1 Date of qualification results	2020-01-31
7.2 Intended start of delivery	2020-10-01
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	11988 Qualification.zip		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2020-02-06

9. Attachments (additional documentations)

11988 Public product.pdf
11988 Qualification.zip
11988 Details.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	SPC560B54L3C6E0X	
	SPC560B60L3C6E0X	
	SPC560B60L5C6E0X	
	SPC560B64L5C6E0X	



Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title : SPC560Bxx (FB64): Activation of TSMC as Additional Diffusion Plant (Following PCI ADG/19/11411)

PCN Reference : ADG/20/11988

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

SPC560B64L5C6E0X	SPC560B54L5C6E0X	SPC560B54L5B6E0Y
SPC560B54L3C6E0X	SPC560B54L3B4E0X	SPC560B60L3B6E0X
SPC560B64L7C6E0X	SPC560B60L7B6E0X	SPC560B60L3C6E0X
SPC560B64L7B6E0X	SPC560B60L5B6E0Y	SPC560B64L3B6E0X
SPC560B60L5C6E0X	SPC560B60L5B6E0X	



IMPORTANT NOTICE – PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST’s terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.